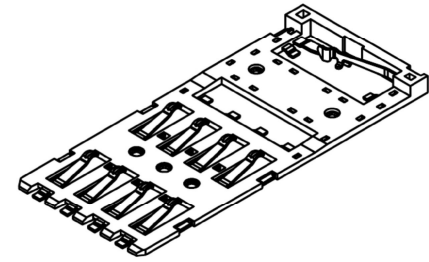
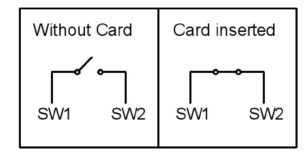


BOARD PAD HOLE
 Recommended PCB Layout
 General Tolerance: ±0.05mm



NOTE:

1. 材料 Material:
 - 1-1 胶壳 Housing: High Temperature Thermoplastic, LCP, Color: Black, UL94V-0
 - 1-2 终端和开关 Terminal and Switch: Phosphor Bronze, T=0.15mm
2. 电镀 Plating:
 - 接触电阻 Contact Area: Gold 3u"
 - 焊接区域 Solder Area: Gold Flash.
 - 底镀 Underplating: Ni overall 50u"min.
3. 规格 Specification:
 - 3-1 触点额定电流 Contact Current Rating: 0.5A
 - 3-2 绝缘耐电压 Dielectric Withstanding Voltage: AC500V r.m.s.
 - 3-3 绝缘电阻 Insulation Resistance: 1000 mΩ Minimum, at DC 500V.
 - 3-4 接触电阻 Contact Resistance: 100 mΩ Maximum.

				ANGULAR	±5°		DSND	SCALE: N/A	MODEL TYPE: SIM CARD CONN		
				L ≤ 4	±0.2		DWN	VIEW:	PART NO.: XKSMC-2100-135		
				4 < L ≤ 16	±0.3		CHKD	UNIT: mm/in	DWG NO.:		
				16 < L ≤ 63	±0.4		APPD	SIZE: A4			
				L > 63	±0.5						
REVISIONS				UNSPECIFIED TOLERANCES					WEIGHT	SHEET	REVISION
www.alpsr.com www.gdxjdz.com www.xbswitch.com						DONG GUAN XI BANG ELECTRONIC CO., LTD				1/1	A0